

Bryan Ackland – Publications

1. Åberg, I., Ackland, B., Beach, J., Godek, C., Johnson, R., King, C., Lattes, A., O'Neill, J., Pappas, S., Sriram, T. and Rafferty, C. "A Low Dark Current and High Quantum Efficiency Monolithic Germanium-on-Silicon CMOS Imager Technology for Day and Night Imaging Applications", *IEEE International Electron Device Meeting*, San Francisco CA, Dec. 2010.
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3. Ackland, B., Rafferty, C., King, C., Aberg, I., O'Neill, J., Sriram, T., Lattes, A., Godek, C. and Pappas, S. "A Monolithic Ge-on-Si CMOS Imager for Short Wave Infrared", *International Image Sensor Workshop*, Bergen, Norway, June 2009. <http://www.imagesensors.org>
4. Rafferty, C., King, C., Ackland, B., Aberg, I., Sriram, T. and O'Neill, J. "Monolithic Germanium SWIR Imaging Array", *SPIE Defense & Security Symposium*, Orlando FL, Apr. 2008, Vol. 6940, No. 20.
5. Ackland, B., Razavi, B. and West, L. "A Comparison of Electrical and Optical Clock Networks in Nanometer Technologies", *IEEE Custom Integrated Circuits Conference*, San Jose CA, Sept. 2005, pp.779-782.
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11. Kalavade, A., Othmer, J., Ackland, B., and Singh, K. "Software Environment for a Multiprocessor DSP", *IEEE/ACM Design Automation Conf.*, New Orleans LA, June 1999, pp. 827-830.
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13. Ackland, B., Anesko, A., Brinthaup, D., Daubert, S., Kalavade, A., Knobloch, J., Micca, E., Moturi, M., Nicol, C., O'Neill, J., Othmer, J., Sackinger, E., Singh, K., Sweey, J., Terman, C. and Williams, J. "A Single Chip 1.6 Billion 16-b MAC/s Multiprocessor DSP", *IEEE Custom Integrated Circuits Conference*, San Diego CA, May 1999, pp. 537-540.
14. Loinaz, M., Singh, K., Blanksby, A., Inglis, D., Azadet, K. and Ackland, B. "A 200 mW, 3.3V CMOS Color Camera IC Producing 352x288 24b Video at 30 Frames/s" *IEEE Journal Solid State Circuits*, Vol. 33, No. 12, Dec. 1998, pp. 2092-2103.
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Granted Patents:

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2. **8,648,948** "Imaging Systems with Multiple Imaging Pixel Types and Related Methods", Feb. 2014.
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4. **20060055800** "Imaging Apparatus and Methods", Mar. 2006